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*(incorporated in the Cayman Islands with limited liability)
(Stock Code: 1360)*

**COMPLETION ANNOUNCEMENT
IN RELATION TO
THE PLACING OF BONDS**

Placing Agent



Financial adviser to the Company



References are made to the announcements of Mega Expo Holdings Limited (the “**Company**”) dated 16 October 2018 and 5 November 2018 (the “**Announcements**”) in relation to the Placing. Unless otherwise defined, terms used in this announcement shall have the same meanings as those defined in the Announcements.

The Board announces that all conditions precedent to Completion as set out in the Placing Agreement had been fulfilled and the Completion took place on 8 November 2018 pursuant to the terms of the Placing Agreement.

At the Completion, the Company issued the Bonds in an aggregate principal amount of HK\$300 million.

By Order of the Board
Mega Expo Holdings Limited
Deng Zhonglin
Chairman

Hong Kong, 8 November 2018

As at the date of this announcement, the Board comprises Mr. Deng Zhonglin and Mr. Xu Feng as executive Directors; and Mr. Choi Hung Fai, Mr. Tsang Wing Ki, Dr. Wong Kong Tin, JP and Mr. Qiu Peiyuan as independent non-executive Directors.